

1.6X1.25mm BI-COLOR SMD CHIP LED LAMP

### **Features**

 $\bullet$  Ideal for indication light on hand held products

• Long life and robust package

• Standard Package: 2,000pcs/ Reel

 $\bullet$  MSL (Moisture Sensitivity Level): 3

• RoHS compliant

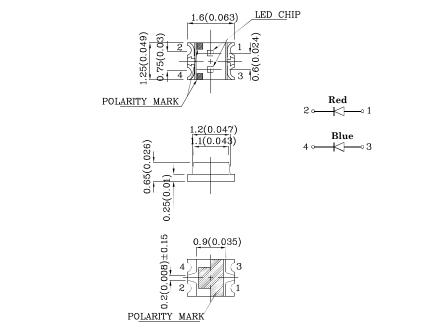






ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

### Package Schematics



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2(0.008")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Red (AlGaInP)	Blue (InGaN)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	$I_{\mathrm{F}}$	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	150	mA
Power Dissipation	$P_D$	75	120	mW
Electrostatic Discharge Threshold (HBM)		3000	250	V
Operating Temperature	$T_{A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

		Red (AlGaInP)	Blue (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.95	3.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	4	V
Reverse Current (Max.) $(V_R=5V)$	$I_{\mathrm{R}}$	10	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	645*	460*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	630*	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	28	25	nm
Capacitance (Typ.) $(V_F=0V, f=1MHz)$	С	35	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} Luminous \ Intensity \\ CIE127\text{-}2007* \\ (I_F\text{=}20\text{mA}) \ mcd \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 2θ 1/2
				min.	typ.		
XZMDKCBD62W-1	Red	AlGaInP	Water Clear	120 40*	198 79*	645*	150°
	Blue	InGaN		40 40*	79 79*	460*	

<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

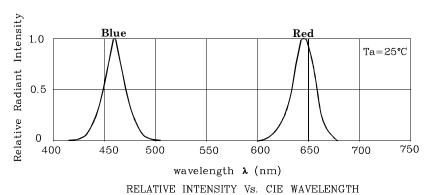
Sep 17,2016

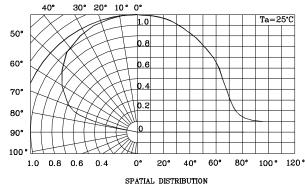
XDSB5712 V4-X Layout: Maggie L.

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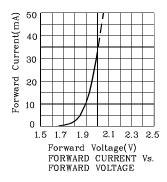


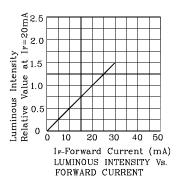


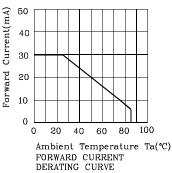


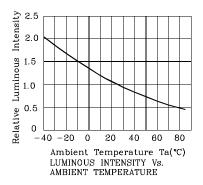


### **❖** Red

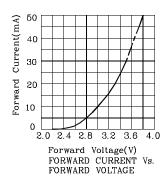


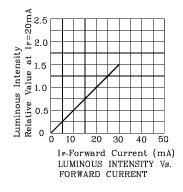


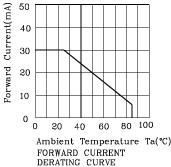


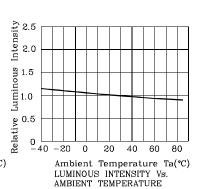


### **♦** Blue







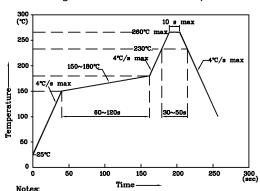






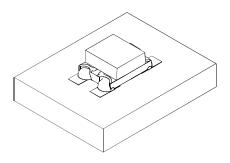
# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

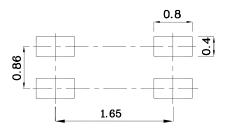


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

❖ The device has a single mounting surface. The device must be mounted according to the specifications.



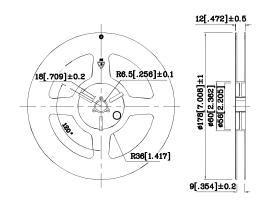
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## **❖** Tape Specification (Units:mm)

# TAPE 4.0±0.1 2.0±0.1 4.0±0.1 0.23±0.1 0.92±0.1 4.2 3.1 3.1

### **❖** Reel Dimension



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

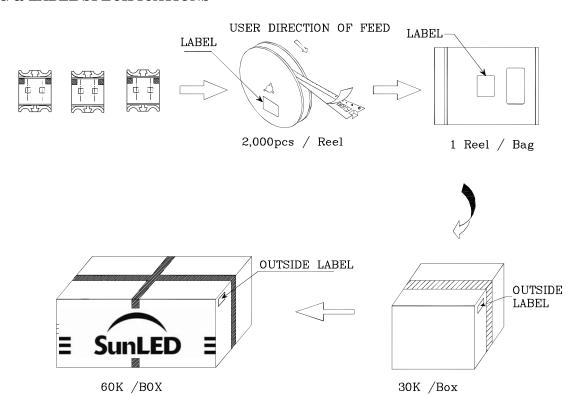
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

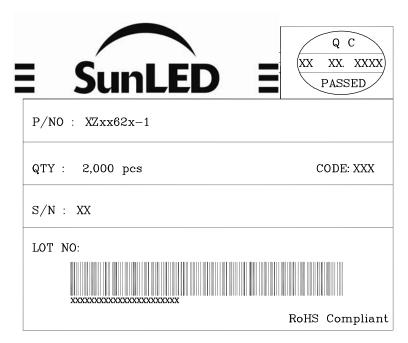
Note: Accuracy may depend on the sorting parameters.



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### PACKING & LABEL SPECIFICATIONS





### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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- 6. Additional technical notes are available at <a href="http://www.SunLEDusa.com/TechnicalNotes.asp">http://www.SunLEDusa.com/TechnicalNotes.asp</a>

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